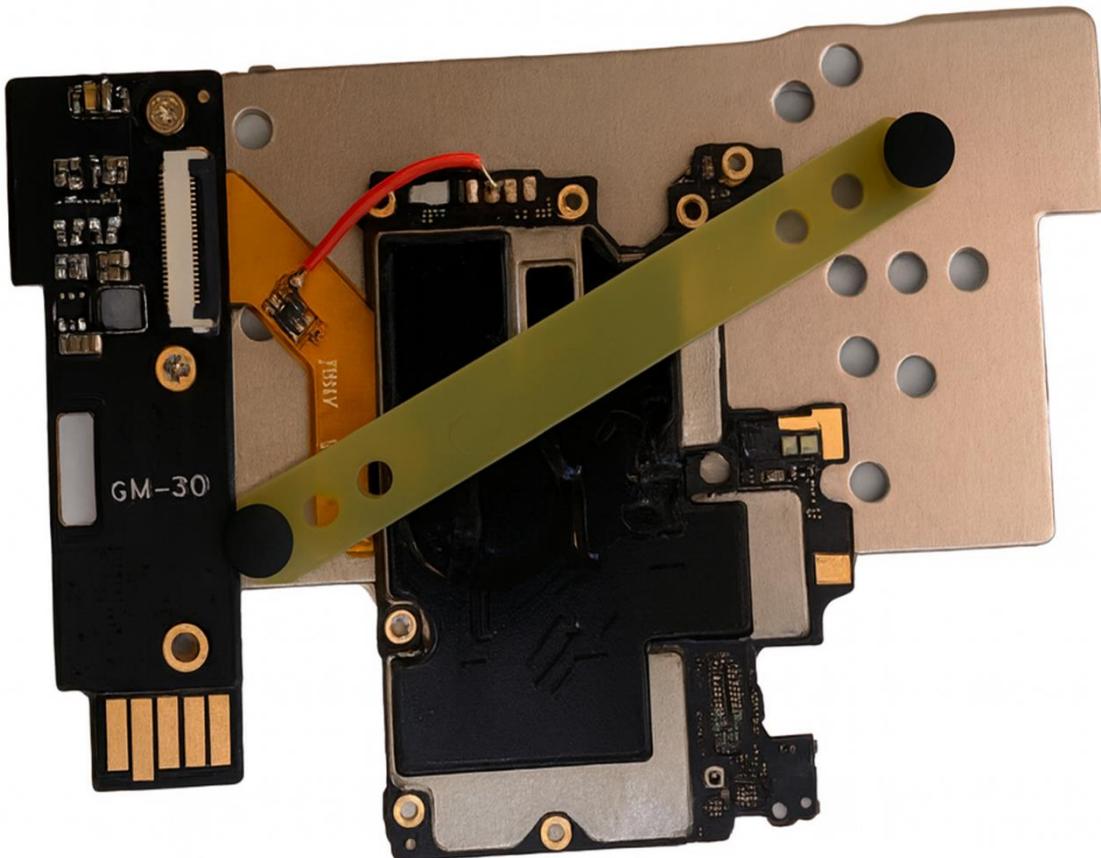


WUC GLOBAL CO. LTD

Refurbished Android Processing Modules

(Non-RF Components)



1. General Description

The refurbished Android processing modules have been restored through a controlled recycling, deep-cleaning, and full functional validation process.

Each unit is reassembled and calibrated for long-term operational stability, providing a cost-efficient and durable alternative to new hardware.

These modules are intended exclusively for technical use as internal processing units.

They are not designed or classified as mobile phones or wireless communication devices.

2. Assembly Nature

Each module is composed of:

- Electronic printed circuit boards (PCBs)
- Internal metal structural elements
- Thermal dissipation components (metal heatsinks and thermal pads)

These internal parts do not constitute casings, antennas, outer shells, or any structure of a cellular terminal.

The device is not classified as an RF unit and does not require telecommunications homologation.

3. Key Features

- Non-RF electronic components: Wi-Fi, Bluetooth, SIM and cellular circuits permanently disabled.
- Factory firmware reinstalled without modifications.
- Integrated assembly of 3 to 4 electronic body sections, depending on the model.
- Stable 24/7 operation validated for automation and testing environments.
- Reassembled structure designed for extended lifespan and consistent performance.
- Each unit is individually tested for parallel and multipoint automation use.

4. Internal Structure & Assembly

- Integrated ARM processor
- Integrated RAM module
- Restored and validated eMMC internal storage
- Internal controllers:
- Power management
- Boot control
- Thermal regulation
- USB/OTG port for power and data communication
- RF circuitry disabled with no active functional paths

5. Interconnection

- Internal connectors compatible with GM-30 systems and other USB multipoint platforms
- Internal flexible ribbon cables linking module sections
- Suitable for integration in automation environments and parallel testing systems

6. Thermal Management

- Primary metal heatsink for stable thermal distribution
- Industrial-grade thermal pads for controlled heat transfer
- Structural design prepared for continuous long-duration operation without overheating

7. Technical Classification & Compliance

- Non-RF electronic component

- Does not operate Wi-Fi, Bluetooth, LTE, GSM, or SIM functions
- Not classified as a mobile terminal or wireless communication device
- Suitable exclusively for controlled environments such as:
- Automation laboratories
- Multi-port platforms
- Parallel test systems
- Internal computing applications

8. Manufacturer Information

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